

# Signal Powered Low Drop Diode Equivalent For Energy Harvesters

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**Abstract-** Piezoelectric-device-based vibration energy harvesting requires a rectifier for conversion of input ac to usable dc form. Power loss due to diode drop in rectifier is a significant fraction of the already low levels of harvested power. The proposed circuit is a low-drop-diode equivalent, which mimics a diode using linear region-operated MOSFET. The proposed diode equivalent is powered directly from input signal and requires no additional power supply for its control. Power used by the control circuit is kept at a bare minimum to have an overall output power improvement. Diode equivalent was used to replace the four diodes in a full-wave bridge rectifier, which is the basic full-wave rectifier and is apart of the more advanced rectifiers like switch-only and bias-flip rectifiers. Simulation in 130-nm technology and experiment with discrete components show that a bridge rectifier with the proposed diode provides a 30–169% increase in output power extracted from piezoelectric device, as compared to a bridge rectifier with diode-connected MOSFETs. The bridge rectifier with the proposed diode can extract 90% of the maximum available power from an ideal piezoelectric device-bridge rectifier circuit. Setting aside the constraint of power loss, simulations indicate that diode drop as low as 10 mV at 38  $\mu$ A can be achieved.

**Index Terms**—Full-wave bridge rectifiers (FBRs), low-drop- diode equivalent (LDDE), piezoelectric devices (PZDs), syn- chronous rectifiers, vibration energy harvesting.

## I. INTRODUCTION

AMBIENT vibration energy can be harvested and converted to useful electrical energy. The electrical energy can be used for powering low-power electronic systems such as sensors, microelectromechanical systems devices, or implantable medical electronics. Vibration energy can be harvested using various types of transducers such as electromagnetic, electrostatic, or piezoelectric. Electromagnetic-device-based harvesters employ a coil to tap energy from a moving magnetic field produced by magnets, which move in the ambient vibration [1]. In electrostatic energy transducers, vibration leads to a relative parallel motion between an electret and nearby metallic surface [2]. This leads to induced counter charge on the metal, with the charge simply following the relative motion of the electrets. This produces an electric current. Piezoelectric harvesters work by stressing a piezoelectric material in accordance with the vibration and tapping the generated electric charge from the material. Electrical energy from any vibration energy harvester device is converted to a load-usable form by an interface circuit, which is connected between the device and its load. The interface circuit consists of a rectifier-filter section for conversion of input ac to dc. The diodes in the rectifier conduct with a voltage drop, leading to power loss. The power loss due to diode drop is a significant fraction of the overall harvested power (10–100  $\mu$ W [3], [4]). It is, therefore, required for the diodes to conduct with minimum voltage drop. Hence, there is a need of a low-drop-diode equivalent (LDDE), which can be used to replace the rectifier diodes. In particular, the LDDE should be able to replace the four diodes in full-wave bridge rectifier (FBR), as FBR is the most common circuit reported in the energy-harvesting literature, sometimes referred to as the standard [5].

The LDDE should meet the following requirements;

- 1) it should have a very low forward conduction drop;
- 2) it should block any reverse conduction;
- 3) it should be able to replace the four diodes in FBR;
- 4) it should not use an additional external power supply;
- 5) it should be powered directly from input signal and not from harvested power. This is to use the available input power instead of the extracted output power;
- 6) it should not demand additional off-chip components;
- 7) the control circuit should draw minimum power.

We propose an LDDE, which meets all of the aforementioned requirements. The LDDE is based on mimicking a low-drop diode with a MOSFET operated in linear region. Such a MOSFET which is controlled such that it conducts in the deep triode region in one direction and goes into subthreshold region

(OFFstate) in the other direction is called a synchronous rectifier.

Previous implementations have also used synchronous rectifiers. However, their control circuit does not meet all of the aforementioned conditions 1–7. CMOS control rectifiers in [6] and [7] and the synchronous full-wave rectifier in [8] need an external power supply for powering up the comparator. Le *et al.* [8] also suggest a passive full-wave rectifier. It, however, requires additional off-chip capacitors. It is also less power efficient owing to the continuous conduction of two diodes by drawing power from the output and also due to reverse conduction by a transistor in saturation region. It also does not show the implementation in FBR.

In [9], a second piezoelectric patch is used to create two stable supply voltages to supply energy to a comparator. In [10], an additional input is required which is 180° out of phase with the input for full-wave rectification.

The proposed LDDE can also be used in voltage multipliers [5], [11] and charge pump [12]. A voltage multiplier with output-powered active diodes is shown in [13]. In [14], a

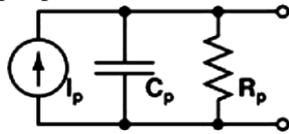


Fig. 1. Equivalent circuit of a PZD at resonance.

current-sensing approach is used for generating the gating signals of output-powered comparator of the MOSFET-based active rectifier. Being output powered, diodes in both [13] and [14] consume standby power. In [15], a MOSFET-based full-wave rectifier followed by a diode to block reverse current conduction is used. The diode is implemented as an active diode powered from the output. The circuit has greatly reduced the diode drop and improved the efficiency. However, the active diode consumes standby power. This issue has been taken care of, in [16] with an input-powered full-wave rectifier and active diode. In [5], the use of gate cross-coupled topologies of MOSFET-based FBR is indicated. This improves the power conversion efficiency. The ideas in [5] and [16] are specific to FBR implementation and are not of a stand-alone LDDE. The synchronous rectifier in [17] suggests a stand-alone LDDE. But it allows reverse conduction. Though the reverse current level can be made small, it cannot be neglected when used in low-power circuits like vibration energy harvesters. There is also a resistor–diode (diode-connected MOSFET) path which is continuously conducting leading to power loss. Work in [17] and [18] has not been suggested for low power (10–100 μW) application.

In this paper, we have proved the efficacy of the proposed LDDE in a piezoelectric device (PZD)-based vibration energy-harvesting system. The electrical equivalent of a PZD [3] when it is vibrated at its resonance frequency is shown in Fig. 1.  $I_p$  is a sinusoidal current source with amplitude equal to  $I_{p\text{peak}}$ .  $I_{p\text{peak}}$  depends on the amplitude of vibration and the frequency  $f_p$  of the current source is equal to the frequency of vibration. Resonant frequency of the PZD is assumed to match with  $f_p$ . From Fig. 1, it is seen that the maximum available power from the PZD with conjugate matching of load is given by

When the rectifier–filter section is introduced at the output of PZD, it sets a further limit on the maximum available power to the load. Let this limit on the maximum available or extractable power be represented by  $P_{\text{EXT(max)}}$ . Then,  $P_{\text{EXT(max)}}$   
 $P_{\text{PZD(max)}}$ .

The proposed LDDE can replace the diodes in various architectures of rectifiers used for PZD-based harvesting. These architectures include conventional FBR, switch-only rectifier [3], [19], bias-flip rectifier [3], series synchronized switching harvesting with inductor (SSHI) [20], [21], synchronous charge extraction circuit [20], [22], voltage doubler [3], resonant rectifier [23], and pulsed-resonant micropower converter [24]. Makihara *et al.* [25] suggest SSHI with two rectification diodes instead of four. Series SSHI with magnetic rectifier [26] uses a transformer to reduce the effective diode drop by a factor equal to

TABLE I

$P_{EXT(max)}$  OF VARIOUS RECTIFIER ARCHITECTURES

Rectifier Architecture	$P_{EXT(max)}$ [3]
FBR	$C_p \cdot (V_p - 2V_D)^2 \cdot f_p$
Voltage Doubler	$C_p \cdot (V_p - V_D)^2 \cdot f_p$
Switch Only Rectifier	$2 \cdot C_p \cdot (V_p - V_D)^2 \cdot f_p$
Bias Flip Rectifier	$2 \cdot C_p \cdot (V_p - \frac{V_D}{Q})^2 \cdot Q \cdot f_p$

$V_p$  is the open circuit voltage amplitude at the output of PZD.  
 $V_D$  is the rectifier diode drop.  
 $R_p$  is ignored in the derivation of  $P_{EXT(max)}$  of the first 3 rectifiers.  
 $Q$  is qualitatively the parallel combination of the Q-factors of PZD and that of the resonant path of  $C_p$  and inductor of bias-flip rectifier.

the transformer ratio. The  $P_{EXT(max)}$  is dependent on the architecture of rectifier. The SSHI and resonant architectures provide a high  $P_{EXT(max)}$ , as compared to the conventional FBR. Table I gives the  $P_{EXT(max)}$  of different architectures. From Table I, it is seen that for all rectifier architectures,  $P_{EXT(max)}$  increases as the rectifier diode drop decreases.

- I. The remainder of this paper is organized as follows. Section II covers the working principle and power considerations of the proposed LDDE. Section III gives the design considerations and the simulation results in 130-nm technology. Section IV describes the detail of an experiment with the proposed LDDE, implemented with discrete components. Finally, Section V concludes this paper.

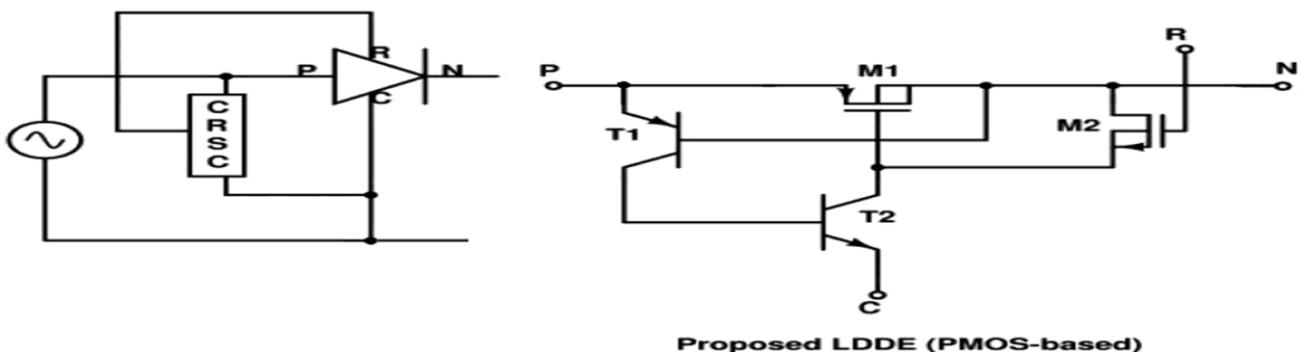
## II. WORKING PRINCIPLE OF THE PROPOSED LDDE

A MOSFET operated in linear region (deep triode region) exhibits a very low value of dc resistance. It can conduct with lesser voltage drop for the same current, as compared to a diode or a diode-connected MOSFET (DCMOS). This property of MOSFET is exploited to use it to mimic a low-drop diode. It may also be noted that a DCMOS cannot be used as a low-drop diode, because of a minimum drop across it which is equal to the threshold voltage of MOSFET.

In the proposed LDDE, MOSFET is controlled such that it conducts only in one direction (call forward direction) and in linear region in the forward direction. A circuit diagram of the proposed LDDE is shown in Fig. 2. Source of PMOS ( $M_1$ ) acts as the anode and drain of  $M_1$  acts as the cathode of LDDE. The emitter-base junction of p-n-p transistor ( $T_1$ ) is across (in parallel with) the source-drain of  $M_1$ . Substrate of  $M_1$  is kept connected to drain to block reverse conduction.

To illustrate the LDDE operation, the following step-by-step description is given:

- 1) When LDDE sees a voltage in the forward direction (positive signal voltage), the emitter-base junction of  $T_1$  is forward biased and  $T_1$  begins to conduct.
- 2) When  $T_1$  conducts, it provides the base drive current to n-p-n BJT ( $T_2$ ) and  $T_2$  enters into conduction.
- 3) The gate-source capacitance  $C_{gs}$  of  $M_1$  gets connected across the PZD through  $T_2$  and  $C_{gs}$  starts getting charged in the negative direction.



Circuit diagram of the proposed LDDE.

4) When the source–gate voltage  $V_{sg}$  of  $M_1$  exceeds threshold voltage of  $M_1$ ,  $M_1$  starts conducting.  
 5)  $C_{gs}$  of  $M_1$  continues to get charged and  $V_{sg}$  of  $M_1$  keeps increasing. As  $V_{sg}$  keeps increasing,  $M_1$  enters from the saturation region into linear region

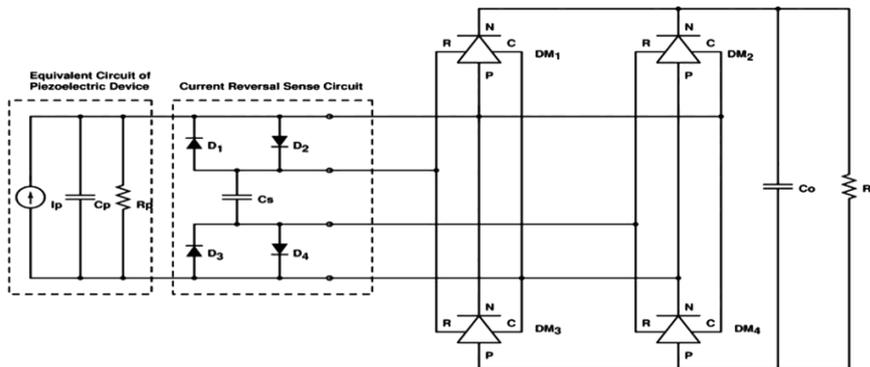
6) When  $M_1$  enters the linear region of conduction, the source–drain voltage of  $M_1$  ( $V_{sd}$ ) reduces to a very low value.

7) When  $T_1$  turns OFF,  $T_2$  turns OFF.

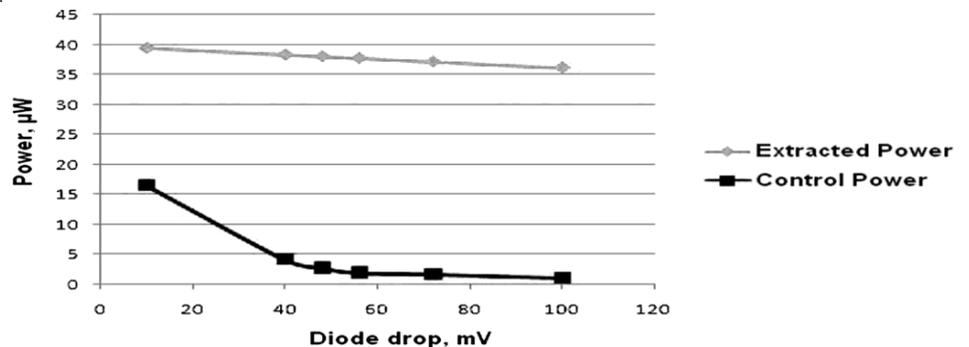
8)  $C_{gs}$  of  $M_1$  stops getting charged. However,  $C_{gs}$  has no path to discharge and  $V_{sg}$  is maintained. This enables  $M_1$  to continue conducting in the linear region. After  $M_1$  starts conducting in the linear region, the drop across the parallel combination of  $M_1$  source–drain and  $T_1$  emitter–base junction is dictated by the linear region characteristic of  $M_1$ . The drop across anode and cathode of the LDDE thus becomes equal to that across a MOSFET in linear region.

9) When signal reverses, signal R gets activated (generation of signal R is discussed shortly). Signal R is a one-diode-drop positive signal w.r.t cathode of LDDE (or anode of LDDE, cathode and anode being at almost the same po- tential).

10) Signal R turns ON the NMOS ( $M_2$ ), which discharges  $C_{dg}$  of  $M_1$  and turns  $M_1$  OFF to prevent reverse conduction.



. FBR and filter for PZD using the proposed LDDE.



Variation of extracted power and control power with diode drop

### III. Simulation Results

The circuit was simulated at an amplitude of  $I_p (I_{pp} \text{ e a k}) = 60 \mu\text{A}$ . The optimum value of load resistance  $R_L$ , corresponding to the maximum output power, was determined by varying  $R_L$  and plotting output power,  $P_o$  versus  $R_L$  (see Fig. 8). Optimum value  $R_{LOP t}$  was determined to be 107 kΩ. All simulation results were taken at  $R_{LOP t}$ , unless otherwise stated

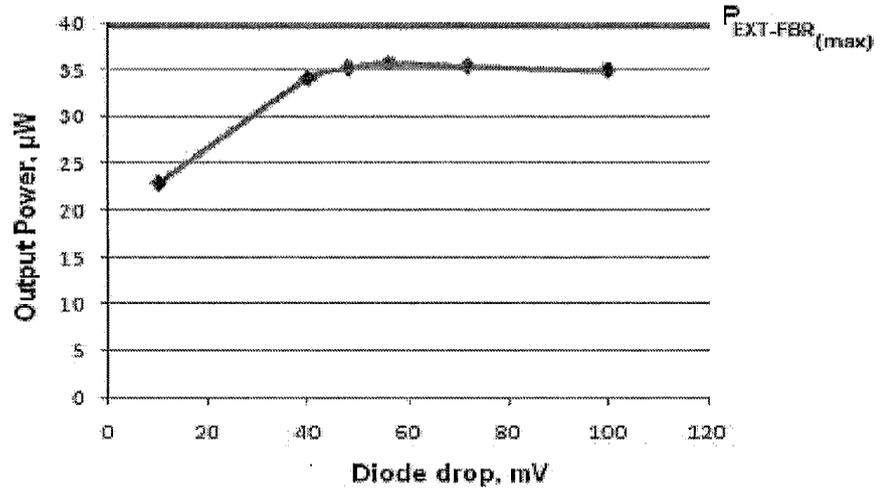


Fig. 7

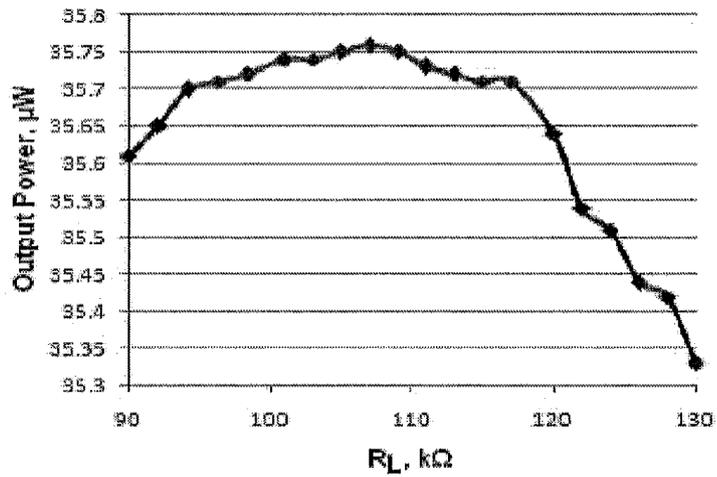


Fig. 8

FIG. 7 shows that the power  $P_o$  maximizes at a diode drop of 56 mV. Also,  $T_1$  is a set of parallel BJTs and the number of  $T_1$ s is based on the number of  $T_2$ s.

The circuit is developed/simulated and tested at an amplitude of  $I_p$  ( $I_{p_{peak}}$ ) equal to  $60 \mu A$ . The optimum value of load resistance  $R_L$ , corresponding to the maximum output power is determined by varying the resistor  $R_L$  and finding the output power  $P_o$ .

FIG. 8 illustrates a plot of  $P_o$  versus  $R_L$  or the variation of output power with load resistance. The optimum value  $R_{L_{opt}}$  was determined to be  $107 k\Omega$ .

The output power  $P_o$  is calculated by measuring  $V_o$  as  $P_o = V_o^2 / R_L(4)$

The circuit is developed/simulated at various values of  $I_{p_{peak}}$ . The LDDE forward conduction drop  $V_D$ , LDDE current, gate control voltage of LDDE, and output voltage  $V_o$  are plotted as shown in FIGS. 9 and 10.

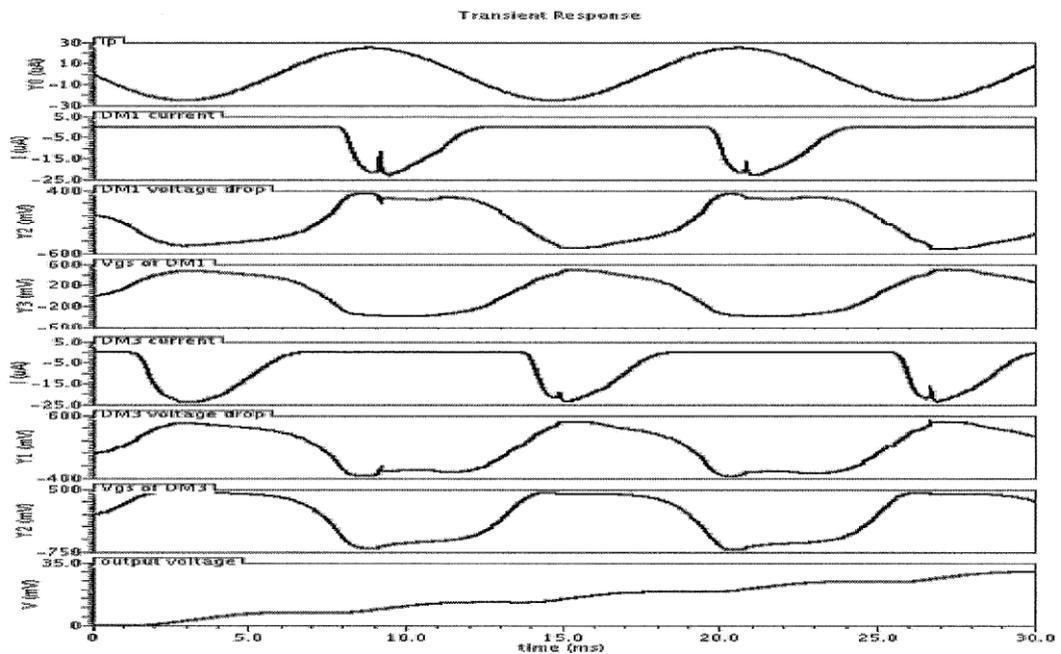


Fig. 9

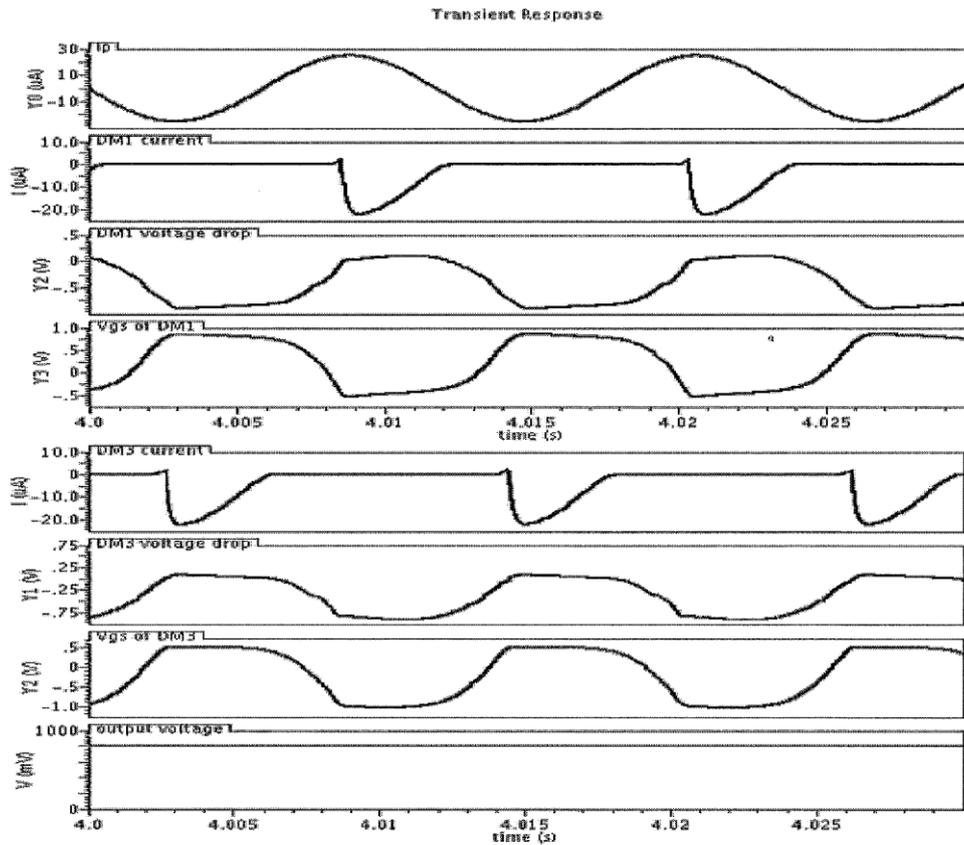


Fig. 10

TABLE II

$P_o$  AND  $\eta$  OF LDDE-BASED FBR AT VARIOUS VALUES OF  $I_{p_{peak}}$

$I_{p_{peak}}$ ( $\mu A$ )	$V_p$ (V)	$P_{EXT-FBR(max)}$ ( $\mu W$ )	$P_o$ ( $\mu W$ )	$\eta$ (%)
20	1.413	4.41	3.71	84.13
30	2.122	9.95	8.83	88.74
40	2.828	17.67	15.55	88.00
50	3.535	27.62	24.38	88.27
60	4.241	39.75	35.76	90.0

When not in the deep triode region, conduction loss is the major loss. As  $R_L$  increases for a fixed  $I_{p_{peak}}$ ,  $V_o$  increases,  $V_{gs}$  increases,  $V_D$  decreases, and, hence, conduction loss decreases with the increase in  $R_L$ . The decrease in conduction loss is also due to the lesser conduction period as  $R_L$  increases. Also, when not in the deep triode region, as  $I_{p_{peak}}$  increases at a fixed  $R_L$ ,  $V_o$  increases,  $V_{gs}$  increases,  $V_D$  decreases at a faster rate than  $I_{p_{peak}}$  increases, and thus conduction loss decreases.

When  $M_1$  enters into the deep triode region, switching loss dominates. For a fixed  $R_L$ , as  $I_{p_{peak}}$  increases,  $V_o$  increases,  $V_{gs}$  increases, and switching loss increases. The conduction loss

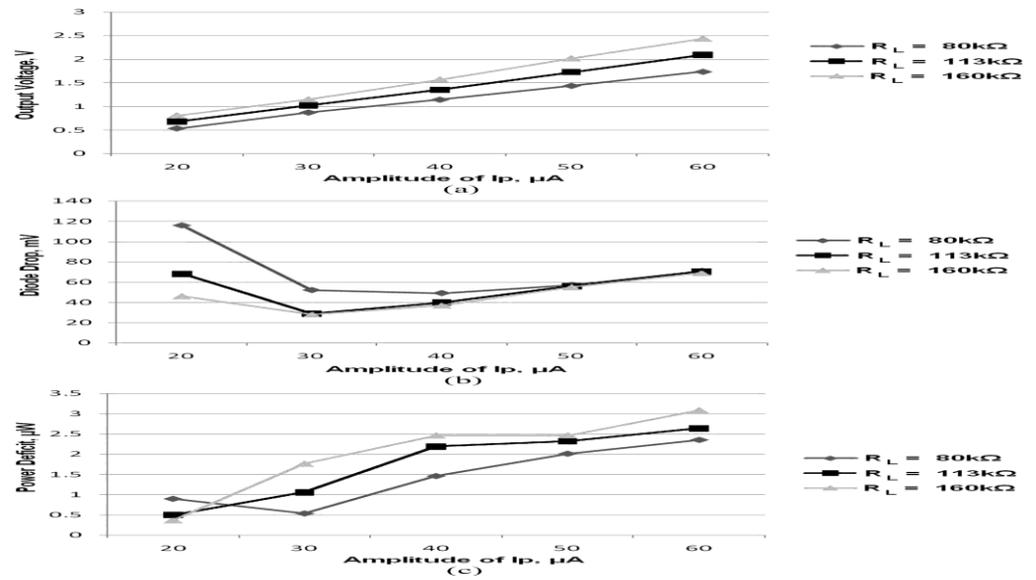


Fig. 11. Performance of LDDE-based FBR as a function of  $I_{p\ peak}$  for various

$R_L$ . (a) Output voltage. (b) Diode drop. (c) Power deficit.

also increases, as in the triode region,  $V_{ds}$  increases with  $I_{ds}$  (or  $I_{p\ peak}$ ). For a fixed  $I_{p\ peak}$ , as  $R_L$  increases,  $V_{gs}$  increases leading to higher switching loss. The variation in  $V_{ds}$  (or  $V_D$ ) with  $R_L$  is insignificant in the deep triode region.

For comparison with the standard DCMOS, the FBR-filter section of PZD was wired with DCMOS and simulated. The DCMOSs used were of the same type and dimension, as  $M_1$  (see Fig. 2) of LDDE, to enable the best comparison.  $R_{L\ opt}$  of DCMOS-based FBR was found to be 111 k $\Omega$ .

Figs. 12 and 13 show that the LDDE scores over DCMOS both in terms of lower  $V_D$  and higher  $P_o$ .  $P_o$  is higher by upto 169% for low values of  $I_{p\ peak}$  and by up to 30% at higher values of  $I_{p\ peak}$ . This trend can be understood from  $P_{EXT(max)}$  of FBR, as given in Table I.

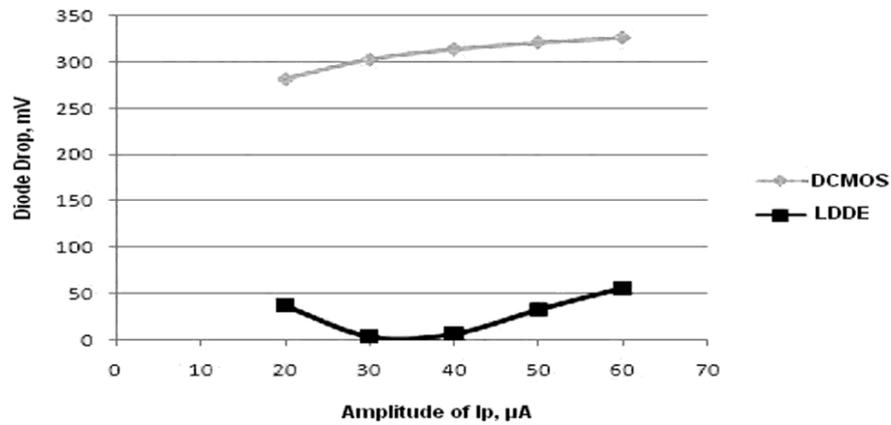
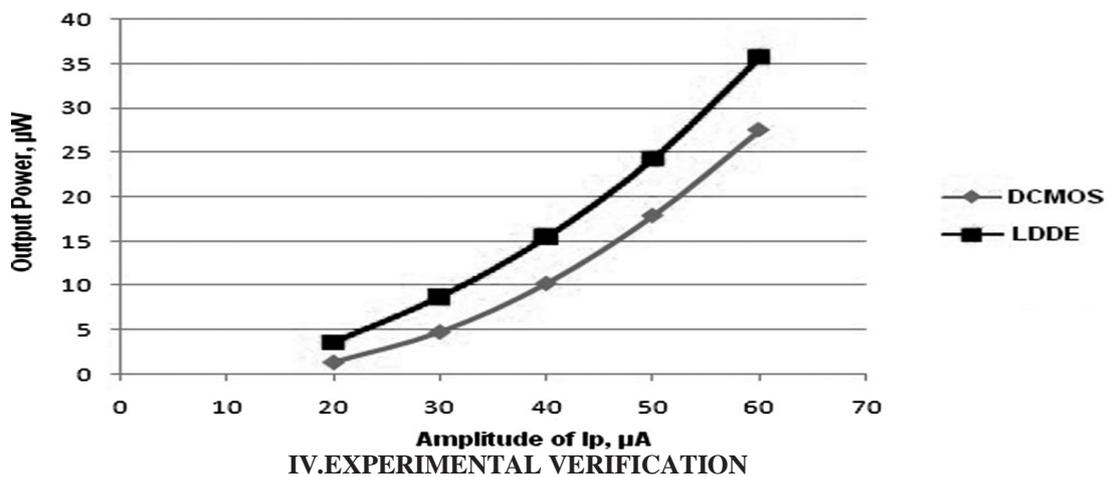


Fig. 12. Comparison of diode drop of LDDE with that of DCMOS.



IV. EXPERIMENTAL VERIFICATION

The FBR-filter section of the interface circuit for PZD-based vibration energy harvesting was rigged up using discrete components. Specified working of the proposed LDDE was verified by wiring it up using discrete components and using it in place of the four diodes in FBR. To enable comparison with the conventional DCMOS, the FBR-filter was configured, both using the proposed LDDE and conventional DCMOS.

A. PZD Detail

The PZD used was Mide Vulture V21BL. It has two piezoelectric strips on the same substrate, but with independent electrical wiring. Each strip has a  $C_p$  of 26 nF.

B. FBR Circuit Details

The LDDE-based FBR was configured using discrete components, as shown in Table IV. The DCMOS-based FBR was configured using the same type of MOSFET as used for LDDE-based FBR to enable the best comparison.

C. Experimental Setup

The PZD was mounted along the datasheet-specified clamp line in a cantilevered configuration on the LDS Dactron shaker, as shown in Fig. 14. The two electrical wires corresponding to one of the piezostrips were taken out and connected to the input of FBR. The wires taken out were arrested properly after giving them enough stress relief. The voltage across different points in the circuit was measured using a digital storage oscilloscope.

The LDS Dactron Shaker gives calibrated sinusoidal vibration in the vertical direction at user-set frequencies and amplitudes (given in terms of acceleration  $g$ ).

D. Measurement Results

1) *Determination of resonance frequency of PZD:* The PZD was vibrated at various frequencies from 50 to 500 Hz at a fixed amplitude of 1g. The amplitude of sinusoidal output from PZD peaked at 85 Hz. Resonance frequency = 85 Hz.

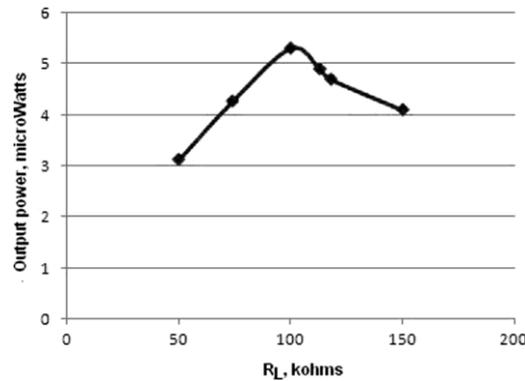


Fig. 15. Variation of the proposed LDDE-based FBR output power with load resistance (frequency of vibration = 85 Hz; acceleration = 0.5g).

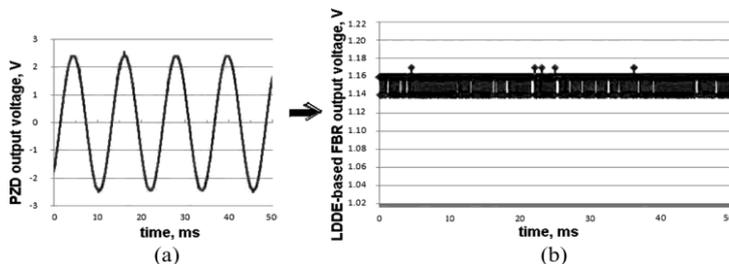


Fig. 16. Output of LDDE-based FBR at 0.8g, 85 Hz vibration of PZD (reproduced from digital oscilloscope-recorded data points). (a) PZD output.

(b) FBR-filter output.

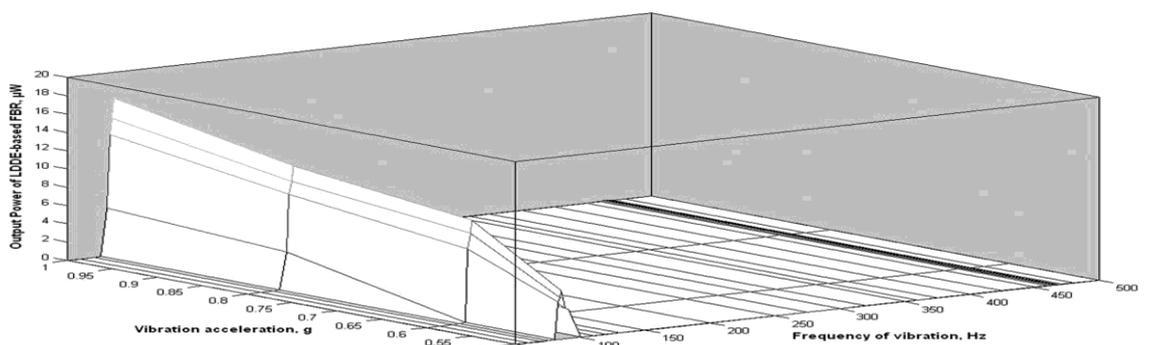


Fig. 17. Output power of LDDE-based FBR at different frequencies and amplitudes of vibration of PZD

1) *Determination of optimum load for the PZD-rectifier circuit:* The PZD was vibrated at 85 Hz, 0.5 g, and the output voltage  $V_o$  from the FBR filter was noted at various values of load resistance  $R_L$ . Output power  $P_o$  in each case was calculated from (4). Output power peaked at  $R_L = 100 \text{ k}\Omega$  (see Fig. 15). Optimum load resistance = 100 k $\Omega$ .  $R_L$  was kept fixed at its optimum value during the rest of the experiment.

*Characterization of LDDE-based FBR:* The PZD was vibrated at various frequencies from 50 to 500 Hz and amplitudes from 0.5g to 1g. The output voltage  $V_o$  of

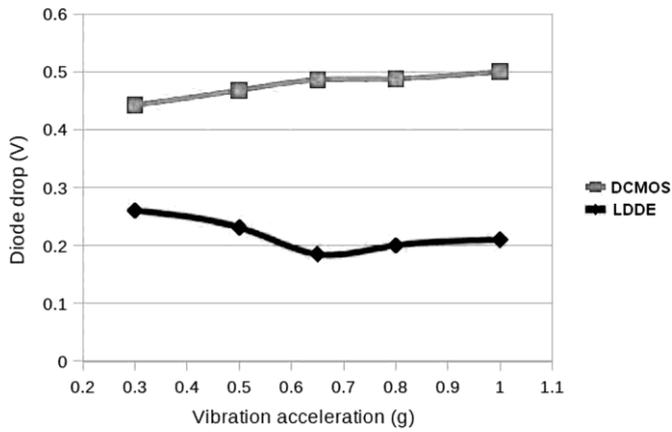


Fig. 18. Comparison of forward conduction drop of LDDE with DCMOS(Vibration Frequency = 85 Hz).

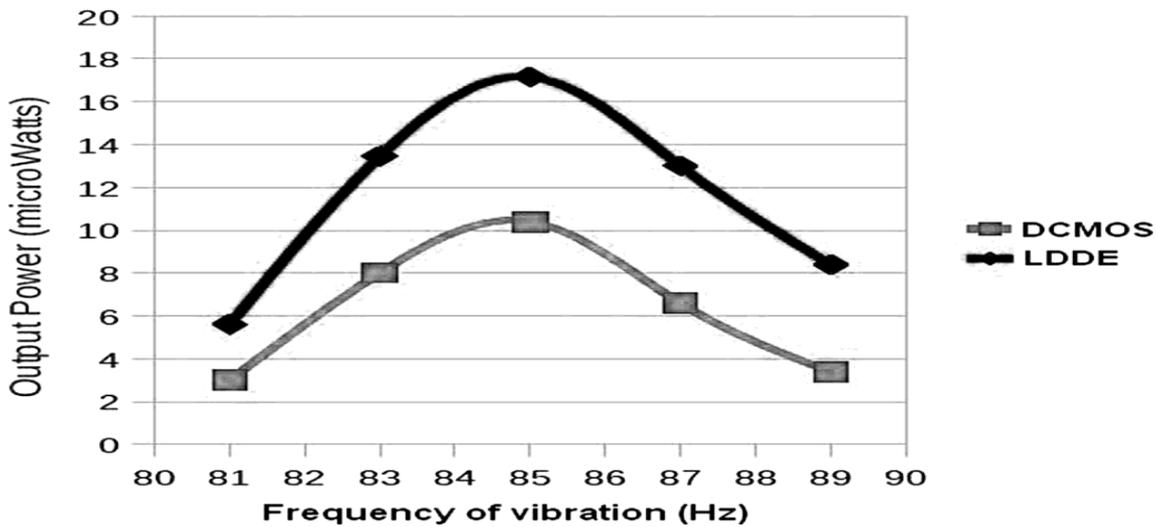
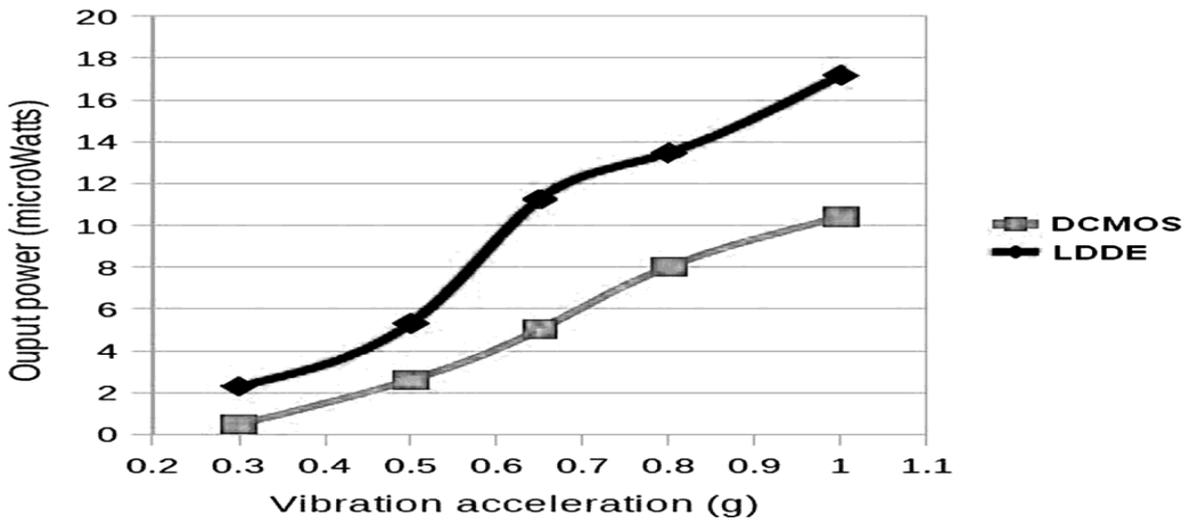


Fig. 20. Comparison of output power from LDDE-based FBR with that from DCMOS-based FBR (Vibration acceleration = 1g).

LDDE-based FBR was measured (see Fig. 16) and recorded in each case. The output power was

calculated from (4). A 3-D plot of output power was made based on these data (see Fig. 17).

- 2) *Comparison of performance of LDDE with that of DC- MOS:* The PZD was vibrated at various frequencies from 81 to 89 Hz and amplitudes from 0.3g to 1g. Rectified voltage at the optimally loaded output of FBR and the diode drop were measured in both the configurations, viz., LDDE-based and conventional DCMOS-based. Out-put power was calculated using (4).

Figs. 18–20 show that the proposed method has a strict advantage over conventional method in terms of lower diode drop and higher output power, under same input conditions.

In general, the LDDE-based FBR provided a 65–104% increase in power as compared to the DCMOS-based FBR

## V. CONCLUSION

A linear region-operated-MOSFET-based LDDE has been proposed. It can be directly powered from input signal and requires no additional power supply. The proposed diode equivalents have been used to replace the four diodes of FBR in PZD interface circuit. The efficacy of the proposed diode in decreasing the diode drop and increasing the output power from a PZD-bridge rectifier circuit has been demonstrated through simulation in 130-nm technology and experiment with discrete components. It provides a 30–169% increase in output power as compared to a bridge rectifier with conventional diode-connected MOSFETs. The simulation in 130-nm technology also shows that it can extract 90% of the maximum available power from an ideal PZD-bridge rectifier circuit. Setting aside the constraint of power loss, simulations indicate that a diode drop as low as 10mV at 38  $\mu$ A can be achieved.

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